

09/285,986

COFC

01 PE

FEB 17 2005

TRANSMITTAL LETTER
(General - Patent Issued)

Docket No.
N1085-90062

Patentee(s): Shih-Shiung Cheu et al.

U.S. Patent No.

6,803,327 B1

Issue Date

October 12, 2004

Title:

**COST EFFECTIVE POLYIMIDE PROCESS TO SOLVE PASSIVATION EXTRUSION OR DAMAGE AND SOG
DELAMINATES**

COMMISSIONER FOR PATENTS:

Transmitted herewith is:

Certificate of Correction and Acknowledgment Postcard.

Certificate
FEB 23 2005
of Correction

- ☐ No additional fee is required.
- ☐ A check in the amount of _____ is attached.
- ☒ The Director is hereby authorized to charge and credit Deposit Account **50-2061**
as described below.
- ☒ Charge the amount of **\$100.00**
- ☒ Credit any overpayment.
- ☒ Charge any additional fee required.
- ☐ Payment by credit card. Form PTO-2038 is attached.

WARNING: Information on this form may become public. Credit card information should not be included on this form. Provide credit card information and authorization on PTO-2038.


Signature

Dated: February 15, 2005

Jeffrey M. Chamberlain, Esq.
Registration No. 55,044

Duane Morris LLP
P.O. Box 5203
Princeton, New Jersey 08543-5203
Tel: (609) 631-2491
Fax: (609) 631-2401

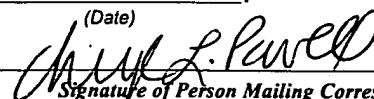
Customer No.: 08933

CC:

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to "Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450" [37 CFR 1.8(a)] on

February 15, 2005

(Date)


Signature of Person Mailing Correspondence

Cheryl L. Powell

Typed or Printed Name of Person Mailing Correspondence

FEB 25 2005

UNITED STATES PATENT AND TRADEMARK OFFICE

CERTIFICATE OF CORRECTION

PATENT NO : 6,803,327 B¹

DATED : October 12, 2004

INVENTOR(S) : Shih-Shiung Cheu, Yea-Dean Sheu and Chih-Heng Shen

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

On the cover page, in the Title, please delete "Delminates" and insert --Delaminates--.

In column 1, in the title, please delete "Delminates" and insert --Delaminates--.

In claim 20, column 10, line 27, please delete "layerpreventing" and insert --layer, preventing--.

MAILING ADDRESS OF SENDER:

Duane Morris LLP
One Liberty Place
Philadelphia, PA 19103-7396

PATENT NO. 6,803,327

No. of additional copies

→ 0

FEB 25 2005